

Features

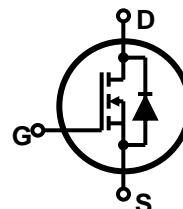
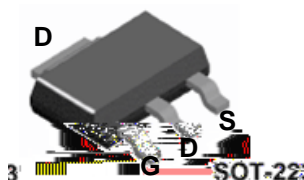
- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- Halogen free package
- JEDEC Qualification

$$V_{DSS} = 330V @ T_{jmax}$$

$$I_D = 3A$$

$$R_{DS(on)} = 2.15 \text{ (max) @ } V_{GS} = 10 \text{ V}$$

$$R_{DS(on)} = 1.73 \text{ (typ) @ } V_{GS} = 10 \text{ V}$$



Device	Package	Marking
TMT3N30G	SOT223	TMT3N30G

Absolute Maximum Ratings

Parameter	Symbol	TMT3N30G	Unit
Drain-Source Voltage	V_{DS}	300	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current	I_D	$T_C = 25 \text{ }^\circ\text{C}$	3.0*
		$T_C = 100 \text{ }^\circ\text{C}$	1.7*
Pulsed Drain Current (Note 1)	I_{DM}	12*	A
Single Pulse Avalanche Energy (Note 2)	E_{AS}	50	mJ
Repetitive Avalanche Current (Note 1)	I_{AR}	3	A
Repetitive Avalanche Energy (Note 1)	E_{AR}	0.2	mJ
Power Dissipation	P_D	$T_C = 25 \text{ }^\circ\text{C}$	2
		Derate above 25 $^\circ\text{C}$	0.02
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~150	$^\circ\text{C}$
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$

* Limited only by maximum junction temperature

Thermal Characteristics

Parameter	Symbol	TMT3N30G	Unit
Maximum Thermal resistance, Junction-to-Ambient	R_{JA}	62.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics : $T_c=25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units
OFF						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ A}$	300	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 300\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	A
		$V_{DS} = 240\text{ V}, T_c = 125^\circ\text{C}$	--	--	10	A
Forward Gate-Source Leakage Current	I_{GSSF}	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
Reverse Gate-Source Leakage Current	I_{GSSR}	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA
ON						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ A}$	2	--	4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 1.5\text{ A}$	--	1.73	2.15	
Forward /F1JE050}TJET Tm[003A}TJET EMC C						

Note :

1. Repeated rating : Pulse width limited by safe operating area
2. $L=9.3\text{mH}$, $I_{AS}=3\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_j=25^\circ\text{C}$
3. $I_{SD}\leq 3\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DS}$, Starting $T_j=25^\circ\text{C}$
4. Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
5. Essentially Independent of Operating Temperature Typical Characteristics

